



INFORMATION DISCLOSURE CITATION

(Use several sheets if necessary)

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41941-00351

SERIAL NO.

10/678,483

Zipparo et al.

FILING

October 2, 2003

GROUP

Not Yet Known

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
mo	1.	5,329,498	07/12/94	Greenstein	367	155	
	2.	6,467,138	10/22/02	Aime	29	25.35	
	3.	5,398,689	03/21/95	Connor et al.	128	662.03	
	4.	5,648,942	07/15/97	Kunkel, III	367	176	
	5.	5,795,299	08/18/98	Eaton et al.	600	459	
	6.	6,100,626	08/08/00	Frey et al.	310	334	
	7.	6,266,857	07/31/01	Corbett, III et al.	29	25.35	
	8.	6,514,618	02/04/03	McKeighen	428	413	
	9.	6,541,896	04/01/03	Piel, Jr. et al.	310	334	
mo	10.	6,559,389	05/06/03	Kornrumpf et al.	174	254	

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
mo	11.	JP 63146699	12/10/86	Japan	—	—	✓	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

mo	12.	Buhrdorf, A. et al; Capacitive Micromachined Ultrasonic Transducers and Their Application; 2001 IEEE Ultrasonic Symposium-933
mo	13.	Noble, R.A., et al; A Cost-effective and Manufacturable Route to the Fabrication of High Density 2D Micromachined Ultrasonic Transducer Arrays and (CMOS) Signal Conditioning Electronics on the Same Silicon Substrate; 2001 IEEE Ultrasonic Symposium-941.

EXAMINER

N. Langley

DATE CONSIDERED

5-19-05

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.



